

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gurtej S. Sandhu et al. Examiner: Dung Le
Serial No.: 10/820,291 Group Art Unit: 2818
Filed: April 8, 2004 Docket: 303.085US7
Title: METHOD FOR FORMING A METALLIZATION LAYER

COMMUNICATION CONCERNING RELATED APPLICATION(S)**MS Amendment**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
09/652619	August 31, 2000	303.085US4	METHOD FOR FORMING A METALLIZATION LAYER


Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,


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By Applicants' Representatives,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being filed using the USPTO's electronic filing system EFS-Web,ans is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 26 day of April, 2006.


Name


Signature